Power Transistors Panasonic

2SB1148, 2SB1148A

Silicon PNP epitaxial planar type

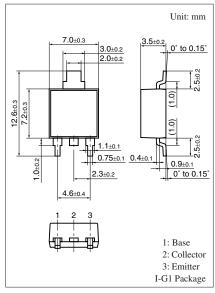
For low-voltage switching Complementary to 2SD1752 and 2SD1752A

■ Features

- Low collector-emitter saturation voltage V_{CE(sat)}
- High-speed switching
- I type package enabling direct soldering of the radiating fin to the printed circuit board, etc. of small electronic equipment

■ Absolute Maximum Ratings $T_C = 25$ °C

Parameter	Symbol	Rating	Unit		
Collector-base voltage	2SB1148	V _{CBO}	-40	V	
(Emitter open)	2SB1148A		-50		
Collector-emitter voltage	2SB1148	V _{CEO}	-20	V	
(Base open)	2SB1148A		-40		
Emitter-base voltage (Col	V _{EBO}	-7	V		
Collector current	I_C	-10	A		
Peak collector current	I_{CP}	-20	A		
Collector power dissipation	P _C	15	W		
	$T_a = 25$ °C		1.3		
Junction temperature	T_{j}	150	°C		
Storage temperature	T _{stg}	−55 ~ +150	°C		

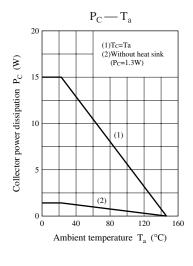


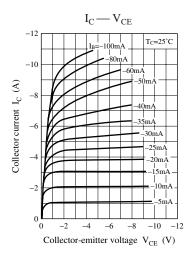
Note) Self-supported type package is also prepared.

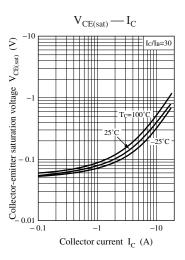
■ Electrical Characteristics $T_C = 25$ ° $C \pm 3$ °C

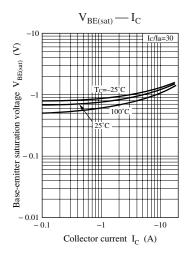
Parameter		Symbol	Conditions	Min	Тур	Max	Unit
Collector-emitter voltage	2SB1148	V _{CEO}	$I_C = -10 \text{ mA}, I_B = 0$	-20			V
(Base open)	2SB1148A			-40			
Collector-base cutoff	2SB1148	I_{CBO}	$V_{CB} = -40 \text{ V}, I_{E} = 0$			-50	μΑ
current (Emitter open)	2SB1148A		$V_{CB} = -50 \text{ V}, I_E = 0$			-50	
Emitter-base cutoff current (Collector open)		I_{EBO}	$V_{EB} = -5 \text{ V}, I_C = 0$			-50	μΑ
Forward current transfer ratio		h _{FE1}	$V_{CE} = -2 \text{ V}, I_{C} = -0.1 \text{ A}$	45			_
		h _{FE2} *	$V_{CE} = -2 \text{ V}, I_{C} = -1 \text{ A}$	90		260	
Collector-emitter saturation voltage		V _{CE(sat)}	$I_C = -10 \text{ A}, I_B = -0.33 \text{ A}$			- 0.6	V
Base-emitter saturation voltage		V _{BE(sat)}	$I_C = -10 \text{ A}, I_B = -0.33 \text{ A}$			-1.5	V
Transition frequency		f_T	$V_{CE} = -10 \text{ V}, I_{C} = -0.5 \text{ A}, f = 10 \text{ MHz}$		100		MHz
Collector output capacitance		C _{ob}	$V_{CB} = -10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$		400		pF
(Common base, input open circuited)							
Turn-on time		t _{on}	$I_C = -3 \text{ A}, I_{B1} = -0.1 \text{ A}, I_{B2} = 0.1 \text{ A}$		0.1		μs
Storage time		t _{stg}	$V_{CC} = -20 \text{ V}$		0.5		μs
Fall time		$t_{\rm f}$			0.1		μs

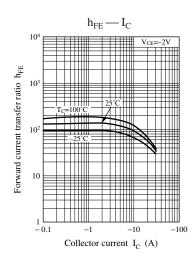
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

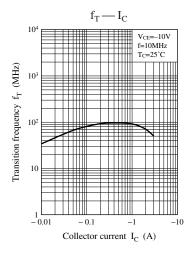


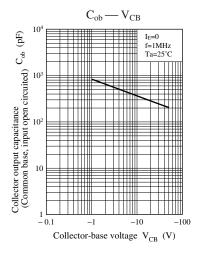


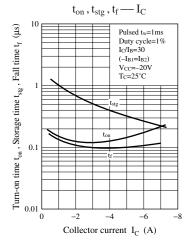


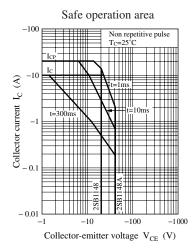


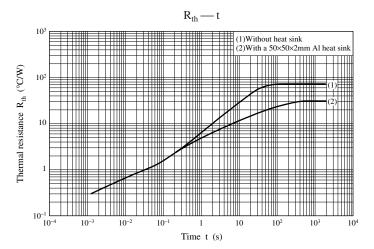












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